

# **SN54LS295B, SN74LS295B**

### 4-Bit Right-Shift Left-Shift Registers

These 4-bit registers feature parallel inputs, parallel outputs, and clock (CLK), serial (SER), mode (LD/SH), and outputs control (OC) inputs. The registers have three modes of operation: parallel, shift right, and shift left.

Parallel loading is accomplished by applying the four bits of data and taking the mode control input high. The data is loaded into the associated flip-flops and appears at the outputs after the high-to-low transition of the clock input. During parallel loading, the entry of serial data is inhibited.

Shift right is accomplished when the mode control is low; shift left is accomplished when the mode control is high by connecting the output of each flip-flop to the parallel input of the previous flip-flop  $(Q_D \text{ to input } C, \text{ etc})$  and serial data is entered at input D.

# Rochester Electronics Manufactured Components

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Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

## **Quality Overview**

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
  - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

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- 'LS295B Offers Three Times the Sink-Current Capability of 'LS295A
- Schottky-Diode-Clamped Transistors
- Low Power Dissipation . . . 80 mW Typical (Enabled)
- Applications:

N-Bit Serial-To-Parallel Converter N-Bit Parallel-To-Serial Converter N-Bit Storage Register

#### description

These 4-bit registers feature parallel inputs, parallel outputs, and clock (CLK), serial (SER), mode (LD/ $\overline{SH}$ ), and outputs control (OC) inputs. The registers have three modes of operation:

Parallel (broadside) load
Shift right (the direction Q<sub>A</sub> toward Q<sub>D</sub>)
Shift left (the direction Q<sub>D</sub> toward Q<sub>A</sub>)

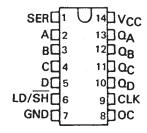
Parallel loading is accomplished by applying the four bits of data and taking the mode control input high. The data is loaded into the associated flip-flops and appears at the outputs after the high-to-low transition of the clock input. During parallel loading, the entry of serial data is inhibited.

Shift right is accomplished when the mode control is low; shift left is accomplished when the mode control is high by connecting the output of each flip-flop to the parallel input of the previous flip-flop (QD to input C, etc.) and serial data is entered at input D.

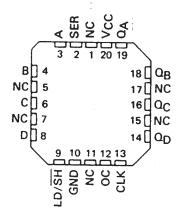
When the output control is high, the normal logic levels of the four outputs are available for driving the loads or bus lines. The outputs are disabled independently from the level of the clock by a low logic level at the output control input. The outputs then present a high impedance and neither load nor drive the bus line; however, sequential operation of the registers is not affected.

The SN54LS295B is characterized for operation over the full military temperature range of -55°C to 125°C; the SN74LS295B is characterized for operation from 0°C to 70°C.

SN54LS295B . . . J OR W PACKAGE SN74LS295B . . . D OR N PACKAGE (TOP VIEW)

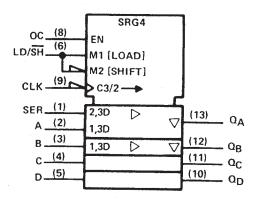


SN54LS295B . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### logic symbol†



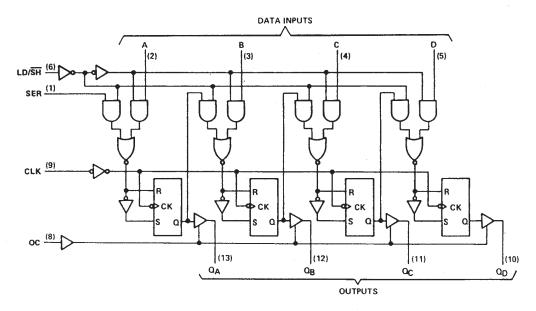
<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



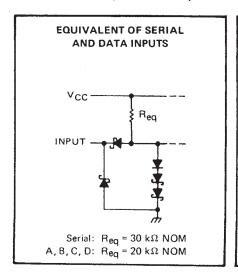
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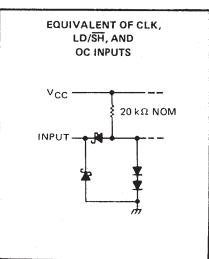
#### logic diagram (positive logic)

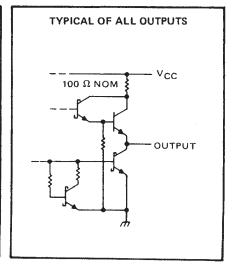


Pin numbers shown are for D, J, N, and W packages.

#### schematics of inputs and outputs







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#### **FUNCTION TABLE**

		INPUTS						OUT	PUTS	
4.5/517	01.1/	050		PARA	LLEL		0.	0-	0-	0-
LD/SH	CLK	SER	Α	В	С	D	Q <sub>A</sub>	QΒ	σC	α <sub>D</sub>
Н	Н	Х	X	X	Х	Х	Q <sub>A0</sub>	$Q_{B0}$	$oldsymbol{co}$	$\sigma_{D0}$
н	↓ ↓	×	a	b	C	d	а	b	c	d
н	<b>↓</b>	×	Q <sub>B</sub> †	Q <sub>C</sub> †	$q_D$ t	d	QBn	$\alpha_{Cn}$	$\mathtt{Q}_{Dn}$	d .
L	Н	×	X	X	X	Х	Q <sub>A0</sub>	$\alpha_{B0}$	$\sigma_{C0}$	$\sigma_{D0}$
L	1	Н	X	X	X	X	Н	$\mathbf{Q}_{An}$	$Q_{Bn}$	$\alpha_{Cn}$
L	<b>↓</b>	L	×	Х	Х	X	L	$Q_{An}$	$Q_{Bn}$	$Q_{Cn}$

When the output control is low, the outputs are disabled to the high-impedance state; however, sequential operation of the registers is not affected.

H = high level (steady state), L = low level (steady state), X = irrelevant (any input, including transitions)

↓ = transition from high to low level.

a, b, c, d = the level of steady-state input at inputs A, B, C, or D, respectively.

 $Q_{A0}$ ,  $Q_{B0}$ ,  $Q_{C0}$ ,  $Q_{D0}$  = the level of  $Q_{A}$ ,  $Q_{B}$ ,  $Q_{C}$ , or  $Q_{D}$ , respectively, before the indicated steady-state input conditions were established.

QAn, QBn, QCn, QDn = the level of QA, QB, QC, or QD, respectively, before the most-recent \$\psi\$ transition of the clock.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)			 							7 V
Input voltage			 							7 V
Operating free-air temperature range:	SN54LS295B		 	. ,			 			-55°C to 125°C
	SN74LS295B			٠.			 			. 0°C to 70°C
Storage temperature range										

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			St	154LS29	95B	SN	UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
ЮН	High-level output current				<b>- 1</b>			- 2.6	mA
IOL	Low-level output current			12			24	mΑ	
fclock	Clock frequency	0		30	0		30	MHz	
tw(clock)	Width of clock pulse	16			16			ns	
t <sub>su</sub>	Setup time, high-level or low-level data		20			20			ns
	Setup time, LD/SH to CLK	high-level	25			25			
<sup>t</sup> su	Setup time, ED/SH to CEN	low-level	30			30			ns
th	Hold time, high-level or low-level data		20			20			ns
th	Hold time, high-level or low-level LD/SH to CLK		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C



 $<sup>^\</sup>dagger$  Shifting left requires external connection of QB to A, QC to B, and QD to C. Serial data is entered at input D.

# SN54LS295B, SN74LS295B 4-BIT RIGHT-SHIFT LEFT-SHIFT REGISTERS WITH 3-STATE OUTPUTS

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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAG AMETER		TEST CONDITIONS!			SN	54LS29	5B	SN	UNIT		
	PARAMETER	TEST CONDITIONS <sup>†</sup>				TYP‡	MAX	MIN	TYP‡	MAX	UNIT
V <sub>IH</sub>	High-level input voltage		-		2			2			V
VIL	Low-level input voltage						0.7			8.0	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	l <sub>1</sub> = -18 mA				-1.5			-1.5	٧
Vон	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = MAX		2.4	3.4		2.4	3.1		٧
V	Law lavel autout valence	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	1 <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	v
VOL	Low-level output voltage	VIL = VIL max		I <sub>OL</sub> = 24 mA					0.35		, v
1	Off-state output current,	V <sub>CC</sub> = MAX,	VIL = VIL max,				20			20	
IOZH	high-level voltage applied	V <sub>O</sub> = 2.7 V					20			20	μΑ
lozL	Off-state output current, low-level voltage applied	V <sub>CC</sub> = MAX,	V <sub>IH</sub> = 2 V,			····	-20			<del>-</del> 20	μΑ
		V <sub>O</sub> = 0.4 V									
lj .	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 7 V				0.1			0.1	mA
ЧН	High-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				20			20	μА
4L	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current §	V <sub>CC</sub> = MAX		·	-30		-130	-30		-130	mA
loo	Supply current		See Nets 2	Condition A		20	29		20	29	
1CC	Supply current	V <sub>CC</sub> = MAX,	See Note 2	Condition B		22	33		22	33	mA

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC is measured with the outputs open, the serial input and mode control at 4.5 V, and the data inputs grounded under the following conditions:

- A. Output control at 4.5 V and a momentary 3 V, then ground, applied to clock input.
- B. Output control and clock input grounded.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25 C, $R_L$ = 667 $\Omega$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub> Maximum clock frequency		30	45	· · · · · · · · · · · · · · · · · · ·	MHz
tpLH Propagation delay time, low-to-high-level output	0 45 5		14	20	ns
tpHL Propagation delay time, high-to-low-level output	C <sub>L</sub> = 45 pF,		19	30	ns
tpZH Output enable time to high level	See Note 3		18	26	ns
tPZL Output enable time to low level			20	30	ns
tPHZ Output disable time from high level	C <sub>L</sub> = 5 pF,		13	20	ns
tPLZ Output disable time from low level	See Note 3		13	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>\</sup>ddagger$ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.



#### PACKAGE OPTION ADDENDUM

18-Sep-2008

#### PACKAGING INFORMATION

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Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN54LS295BJ	OBSOLETE	CDIP	J	14	TBD	Call TI	Call TI
SN74LS295BN	OBSOLETE	PDIP	N	14	TBD	Call TI	Call TI
SN74LS295BN	OBSOLETE	PDIP	N	14	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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